PATENT



Application No.:

10/766,210

Filing Date:

January 29, 2004

Applicant:

Yong-Kwan LEE

Group Art Unit:

2818

Examiner:

Tu Tu V. Ho

Title:

FLIP CHIP PACKAGE HAVING PROTECTIVE CAP

AND METHOD OF FABRICATING THE SAME

Attorney Docket:

2557-000202/US

Customer Service Window Randolph Building 401 Dulany Street Alexandria, VA 22314

September 28, 2005

Mail Stop AF

AMENDMENT UNDER 37 C.F.R. § 1.116

Sir:

In response to the Office Action (hereinafter 'Action') dated July 20, 2005, the following amendments and remarks are respectfully submitted in connection with the aboveidentified application:

Amendments to the Specification begin on page 2,

Amendments to the Drawings begin on page 3,

Amendments to the Claims begin on page 4, and

Remarks begin on page 7 of this Amendment.